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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	AVR
Core Size	8-Bit
Speed	16MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	32
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atmega32a-pu

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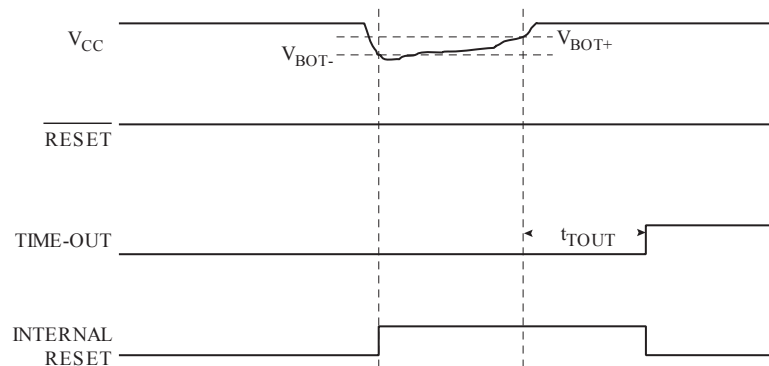
14.2.3. Brown-out Detection

ATmega32A has an On-chip Brown-out Detection (BOD) circuit for monitoring the V_{CC} level during operation by comparing it to a fixed trigger level. The trigger level for the BOD can be selected by the fuse BODLEVEL to be 2.7V (BODLEVEL unprogrammed), or 4.0V (BODLEVEL programmed). The trigger level has a hysteresis to ensure spike free Brown-out Detection. The hysteresis on the detection level should be interpreted as $V_{BOT+} = V_{BOT} + V_{HYST}/2$ and $V_{BOT-} = V_{BOT} - V_{HYST}/2$.

The BOD circuit can be enabled/disabled by the fuse BODEN. When the BOD is enabled (BODEN programmed), and V_{CC} decreases to a value below the trigger level (V_{BOT-} in the figure below), the Brown-out Reset is immediately activated. When V_{CC} increases above the trigger level (V_{BOT+} in the figure below), the delay counter starts the MCU after the time-out period t_{TOUT} has expired.

The BOD circuit will only detect a drop in V_{CC} if the voltage stays below the trigger level for longer than t_{BOD} given in the table in *System and Reset Characteristics*.

Figure 14-5. Brown-out Reset During Operation



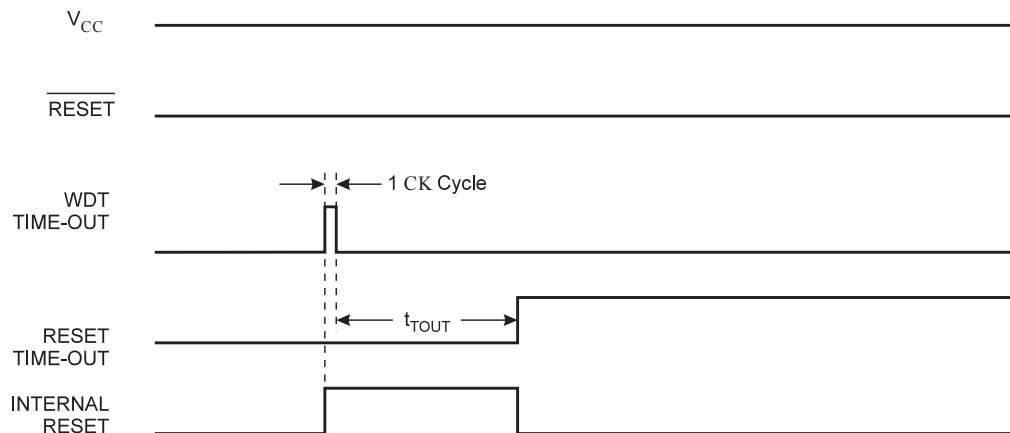
Related Links

[System and Reset Characteristics](#) on page 363

14.2.4. Watchdog Reset

When the Watchdog times out, it will generate a short reset pulse of 1 CK cycle duration. On the falling edge of this pulse, the delay timer starts counting the time-out period t_{TOUT} . Refer to Watchdog Timer for details on operation of the Watchdog Timer.

Figure 14-6. Watchdog Reset During Operation



16.1.3. GICR – General Interrupt Control Register

When using the I/O specific commands IN and OUT, the I/O addresses 0x00 - 0x3F must be used. When addressing I/O Registers as data space using LD and ST instructions, 0x20 must be added to these offset addresses.

Name: GICR

Offset: 0x3B

Reset: 0

Property: When addressing I/O Registers as data space the offset address is 0x5B

Bit	7	6	5	4	3	2	1	0
	INT1	INT0	INT2					
Access	R/W	R/W	R/W					
Reset	0	0	0					

Bit 7 – INT1: External Interrupt Request 1 Enable

When the INT1 bit is set (one) and the I-bit in the Status Register (SREG) is set (one), the external pin interrupt is enabled. The Interrupt Sense Control1 bits 1/0 (ISC11 and ISC10) in the MCU general Control Register (MCUCR) define whether the external interrupt is activated on rising and/or falling edge of the INT1 pin or level sensed. Activity on the pin will cause an interrupt request even if INT1 is configured as an output. The corresponding interrupt of External Interrupt Request 1 is executed from the INT1 Interrupt Vector.

Bit 6 – INT0: External Interrupt Request 0 Enable

When the INT0 bit is set (one) and the I-bit in the Status Register (SREG) is set (one), the external pin interrupt is enabled. The Interrupt Sense Control0 bits 1/0 (ISC01 and ISC00) in the MCU general Control Register (MCUCR) define whether the external interrupt is activated on rising and/or falling edge of the INT0 pin or level sensed. Activity on the pin will cause an interrupt request even if INT0 is configured as an output. The corresponding interrupt of External Interrupt Request 0 is executed from the INT0 Interrupt Vector.

Bit 5 – INT2: External Interrupt Request 2 Enable

When the INT2 bit is set (one) and the I-bit in the Status Register (SREG) is set (one), the external pin interrupt is enabled. The Interrupt Sense Control2 bit (ISC2) in the MCU Control and Status Register (MCUCSR) defines whether the External Interrupt is activated on rising or falling edge of the INT2 pin. Activity on the pin will cause an interrupt request even if INT2 is configured as an output. The corresponding interrupt of External Interrupt Request 2 is executed from the INT2 Interrupt Vector.

SDA, Two-wire Serial Interface Data: When the TWEN bit in TWCR is set (one) to enable the Two-wire Serial Interface, pin PC1 is disconnected from the port and becomes the Serial Data I/O pin for the Two-wire Serial Interface. In this mode, there is a spike filter on the pin to suppress spikes shorter than 50 ns on the input signal, and the pin is driven by an open drain driver with slew-rate limitation. When this pin is used by the Two-wire Serial Interface, the pull-up can still be controlled by the PORTC1 bit.

• **SCL – Port C, Bit 0**

SCL, Two-wire Serial Interface Clock: When the TWEN bit in TWCR is set (one) to enable the Two-wire Serial Interface, pin PC0 is disconnected from the port and becomes the Serial Clock I/O pin for the Two-wire Serial Interface. In this mode, there is a spike filter on the pin to suppress spikes shorter than 50 ns on the input signal, and the pin is driven by an open drain driver with slew-rate limitation. When this pin is used by the Two-wire Serial Interface, the pull-up can still be controlled by the PORTC0 bit.

The tables below relate the alternate functions of Port C to the overriding signals shown in [Alternate Port Functions](#).

Table 17-10. Overriding Signals for Alternate Functions in PC7:PC4

Signal Name	PC7/TOSC2	PC6/TOSC1	PC5/TDI	PC4/TDO
PUOE	AS2	AS2	JTAGEN	JTAGEN
PUOV	0	0	1	0
DDOE	AS2	AS2	JTAGEN	JTAGEN
DDOV	0	0	0	SHIFT_IR + SHIFT_DR
PVOE	0	0	0	JTAGEN
PVOV	0	0	0	TDO
DIEOE	AS2	AS2	JTAGEN	JTAGEN
DIEOV	0	0	0	0
DI	–	–	–	–
AIO	T/C2 OSC OUTPUT	T/C2 OSC INPUT	TDI	–

Table 17-11. Overriding Signals for Alternate Functions in PC3:PC0⁽¹⁾

Signal Name	PC3/TMS	PC2/TCK	PC1/SDA	PC0/SCL
PUOE	JTAGEN	JTAGEN	TWEN	TWEN
PUOV	1	1	PORTC1 • $\overline{\text{PUD}}$	PORTC0 • $\overline{\text{PUD}}$
DDOE	JTAGEN	JTAGEN	TWEN	TWEN
DDOV	0	0	SDA_OUT	SCL_OUT
PVOE	0	0	TWEN	TWEN
PVOV	0	0	0	0
DIEOE	JTAGEN	JTAGEN	0	0

17.4.3. DDRA – Port A Data Direction Register

When using the I/O specific commands IN and OUT, the I/O addresses 0x00 - 0x3F must be used. When addressing I/O Registers as data space using LD and ST instructions, 0x20 must be added to these offset addresses.

Name: DDRA

Offset: 0x1A

Reset: 0

Property: When addressing I/O Registers as data space the offset address is 0x3A

Bit	7	6	5	4	3	2	1	0
	DDA7	DDA6	DDA5	DDA4	DDA3	DDA2	DDA1	DDA0
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bits 7:0 – DDAn: Port A Data Direction Register [n = 7:0]

Input Capture interrupt. The ICFn Flag is automatically cleared when the interrupt is executed. Alternatively the ICFn Flag can be cleared by software by writing a logical one to its I/O bit location.

Reading the 16-bit value in the *Input Capture Register* (ICRn) is done by first reading the Low byte (ICRnL) and then the High byte (ICRnH). When the Low byte is read the High byte is copied into the High byte temporary register (TEMP). When the CPU reads the ICRnH I/O location it will access the TEMP Register.

The ICRn Register can only be written when using a Waveform Generation mode that utilizes the ICRn Register for defining the counter's TOP value. In these cases the *Waveform Generation mode* (WGMn3:0) bits must be set before the TOP value can be written to the ICRn Register. When writing the ICRn Register the High byte must be written to the ICRnH I/O location before the Low byte is written to ICRnL.

For more information on how to access the 16-bit registers refer to [Accessing 16-bit Registers](#).

19.6.1. Input Capture Pin Source

The main trigger source for the Input Capture unit is the *Input Capture Pin* (ICPn). Timer/Counter 1 can alternatively use the Analog Comparator Output as trigger source for the Input Capture unit. The Analog Comparator is selected as trigger source by setting the *Analog Comparator Input Capture* (ACIC) bit in the *Analog Comparator Control and Status Register* (ACSR). Be aware that changing trigger source can trigger a capture. The Input Capture Flag must therefore be cleared after the change.

Both the *Input Capture Pin* (ICPn) and the *Analog Comparator Output* (ACO) inputs are sampled using the same technique as for the Tn pin (see figure *Tn Pin Sampling* in section *External Clock Source*). The edge detector is also identical. However, when the noise canceler is enabled, additional logic is inserted before the edge detector, which increases the delay by four system clock cycles. Note that the input of the noise canceler and edge detector is always enabled unless the Timer/Counter is set in a Waveform Generation mode that uses ICRn to define TOP.

An Input Capture can be triggered by software by controlling the port of the ICPn pin.

Related Links

[External Clock Source](#) on page 102

19.6.2. Noise Canceler

The noise canceler improves noise immunity by using a simple digital filtering scheme. The noise canceler input is monitored over four samples, and all four must be equal for changing the output that in turn is used by the edge detector.

The noise canceler is enabled by setting the *Input Capture Noise Canceler* (ICNCn) bit in *Timer/Counter Control Register B* (TCCRnB). When enabled the noise canceler introduces additional four system clock cycles of delay from a change applied to the input, to the update of the ICRn Register. The noise canceler uses the system clock and is therefore not affected by the prescaler.

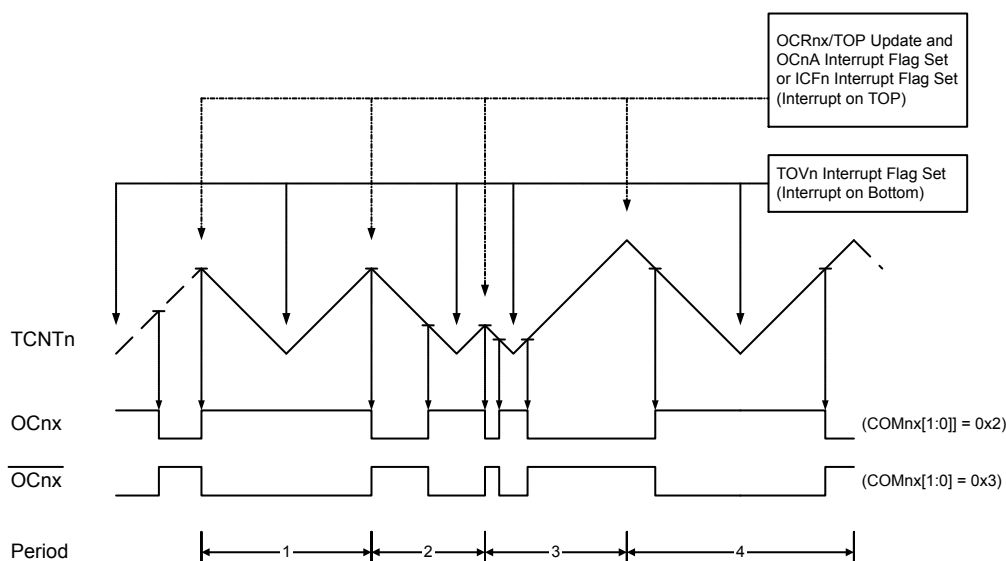
19.6.3. Using the Input Capture Unit

The main challenge when using the Input Capture unit is to assign enough processor capacity for handling the incoming events. The time between two events is critical. If the processor has not read the captured value in the ICRn Register before the next event occurs, the ICRn will be overwritten with a new value. In this case the result of the capture will be incorrect.

When using the Input Capture interrupt, the ICRn Register should be read as early in the interrupt handler routine as possible. Even though the Input Capture interrupt has relatively high priority, the maximum interrupt response time is dependent on the maximum number of clock cycles it takes to handle any of the other interrupt requests.

In phase correct PWM mode the counter is incremented until the counter value matches either one of the fixed values 0x00FF, 0x01FF, or 0x03FF (WGMn3:0 = 1, 2, or 3), the value in ICRn (WGMn3:0 = 10), or the value in OCRnA (WGMn3:0 = 11). The counter has then reached the TOP and changes the count direction. The TCNTn value will be equal to TOP for one timer clock cycle. The timing diagram for the phase correct PWM mode is shown in the figure below. The figure shows phase correct PWM mode when OCRnA or ICRn is used to define TOP. The TCNTn value is in the timing diagram shown as a histogram for illustrating the dual-slope operation. The diagram includes non-inverted and inverted PWM outputs. The small horizontal line marks on the TCNTn slopes represent compare matches between OCRnx and TCNTn. The OCnx Interrupt Flag will be set when a Compare Match occurs.

Figure 19-8. Phase Correct PWM Mode, Timing Diagram



The Timer/Counter Overflow Flag (TOVn) is set each time the counter reaches BOTTOM. When either OCRnA or ICRn is used for defining the TOP value, the OCnx or ICFn Flag is set accordingly at the same timer clock cycle as the OCRnx Registers are updated with the double buffer value (at TOP). The Interrupt Flags can be used to generate an interrupt each time the counter reaches the TOP or BOTTOM value.

When changing the TOP value the program must ensure that the new TOP value is higher or equal to the value of all of the Compare Registers. If the TOP value is lower than any of the Compare Registers, a Compare Match will never occur between the TCNTn and the OCRnx. Note that when using fixed TOP values, the unused bits are masked to zero when any of the OCRnx Registers are written. As the third period shown in the timing diagram above illustrates, changing the TOP actively while the Timer/Counter is running in the Phase Correct mode can result in an unsymmetrical output. The reason for this can be found in the time of update of the OCRnx Register. Since the OCRnx update occurs at TOP, the PWM period starts and ends at TOP. This implies that the length of the falling slope is determined by the previous TOP value, while the length of the rising slope is determined by the new TOP value. When these two values differ the two slopes of the period will differ in length. The difference in length gives the unsymmetrical result on the output.

It is recommended to use the Phase and Frequency Correct mode instead of the Phase Correct mode when changing the TOP value while the Timer/Counter is running. When using a static TOP value there are practically no differences between the two modes of operation.

In phase correct PWM mode, the compare units allow generation of PWM waveforms on the OCnx pins. Setting the COMnx1:0 bits to 2 will produce a non-inverted PWM and an inverted PWM output can be generated by setting the COMnx1:0 to 3. Refer to [Table 19-4](#). The actual OCnx value will only be visible

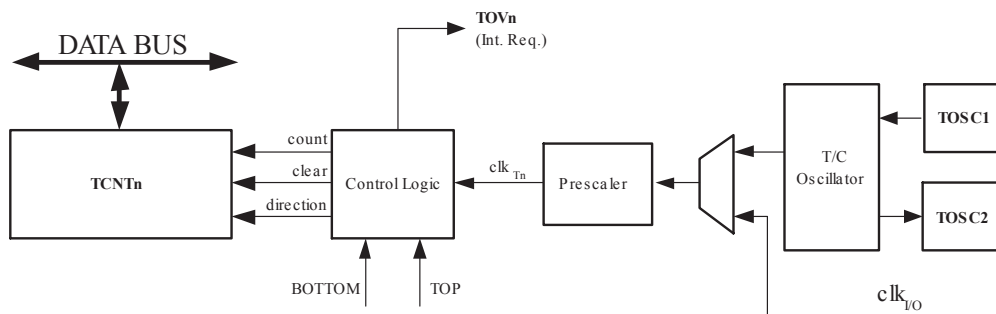
19.11.10. ICR1H – Input Capture Register 1 High byte

Name: ICR1H
Offset: 0x27
Reset: 0x00
Property: When addressing I/O Registers as data space the offset address is 0x47

Bit	7	6	5	4	3	2	1	0
	ICR1H[7:0]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bits 7:0 – ICR1H[7:0]: Input Capture 1 High byte
Refer to [ICR1L](#).

Figure 20-2. Counter Unit Block Diagram



Signal description (internal signals):

count	Increment or decrement TCNT2 by 1.
direction	Selects between increment and decrement.
clear	Clear TCNT2 (set all bits to zero).
clk_{T2}	Timer/Counter clock.
TOP	Signalizes that TCNT2 has reached maximum value.
BOTTOM	Signalizes that TCNT2 has reached minimum value (zero).

Depending on the mode of operation used, the counter is cleared, incremented, or decremented at each timer clock (clk_{T2}). clk_{T2} can be generated from an external or internal clock source, selected by the clock select bits (CS22:0). When no clock source is selected (CS22:0 = 0) the timer is stopped. However, the TCNT2 value can be accessed by the CPU, regardless of whether clk_{T2} is present or not. A CPU write overrides (has priority over) all counter clear or count operations.

The counting sequence is determined by the setting of the WGM21 and WGM20 bits located in the Timer/Counter Control Register (TCCR2). There are close connections between how the counter behaves (counts) and how waveforms are generated on the Output Compare Output OC2. For more details about advanced counting sequences and waveform generation, refer to [Modes of Operation](#).

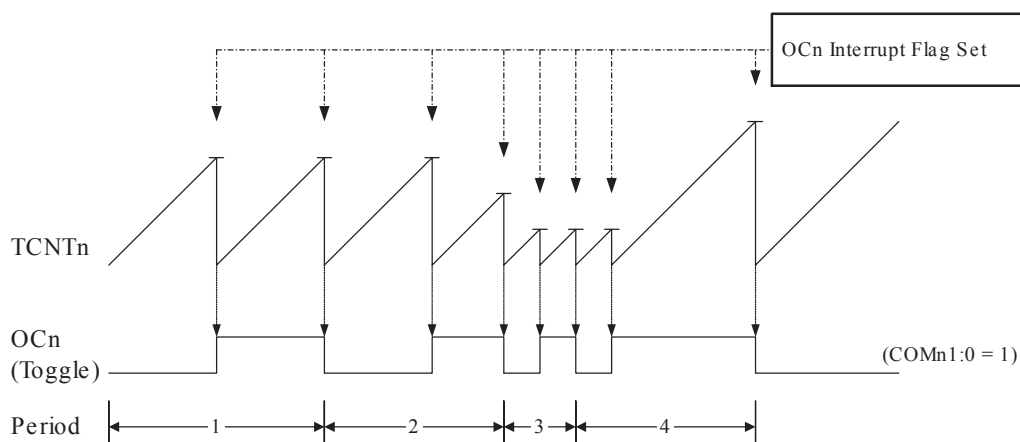
The Timer/Counter Overflow (TOV2) Flag is set according to the mode of operation selected by the WGM21:0 bits. TOV2 can be used for generating a CPU interrupt.

20.5. Output Compare Unit

The 8-bit comparator continuously compares TCNT2 with the Output Compare Register (OCR2). Whenever TCNT2 equals OCR2, the comparator signals a match. A match will set the Output Compare Flag (OCF2) at the next timer clock cycle. If enabled (OCIE2 = 1), the Output Compare Flag generates an Output Compare interrupt. The OCF2 Flag is automatically cleared when the interrupt is executed. Alternatively, the OCF2 Flag can be cleared by software by writing a logical one to its I/O bit location. The waveform generator uses the match signal to generate an output according to operating mode set by the WGM21:0 bits and Compare Output mode (COM21:0) bits. The max and bottom signals are used by the waveform generator for handling the special cases of the extreme values in some modes of operation (refer to [Modes of Operation](#)).

The following figure shows a block diagram of the Output Compare unit.

Figure 20-5. CTC Mode, Timing Diagram



An interrupt can be generated each time the counter value reaches the TOP value by using the OCF2 Flag. If the interrupt is enabled, the interrupt handler routine can be used for updating the TOP value. However, changing the TOP to a value close to BOTTOM when the counter is running with none or a low prescaler value must be done with care since the CTC mode does not have the double buffering feature. If the new value written to OCR2 is lower than the current value of TCNT2, the counter will miss the Compare Match. The counter will then have to count to its maximum value (0xFF) and wrap around starting at 0x00 before the Compare Match can occur.

For generating a waveform output in CTC mode, the OC2 output can be set to toggle its logical level on each Compare Match by setting the Compare Output mode bits to toggle mode (COM21:0 = 1). The OC2 value will not be visible on the port pin unless the data direction for the pin is set to output. The waveform generated will have a maximum frequency of $f_{OC2} = f_{clk_I/O}/2$ when OCR2 is set to zero (0x00). The waveform frequency is defined by the following equation:

$$f_{OCn} = \frac{f_{clk_I/O}}{2 \cdot N \cdot (1 + OCRn)}$$

The N variable represents the prescaler factor (1, 8, 32, 64, 128, 256, or 1024).

As for the Normal mode of operation, the TOV2 Flag is set in the same timer clock cycle that the counter counts from MAX to 0x00.

20.7.3. Fast PWM Mode

The fast Pulse Width Modulation or fast PWM mode (WGM21:0 = 3) provides a high frequency PWM waveform generation option. The fast PWM differs from the other PWM option by its single-slope operation. The counter counts from BOTTOM to MAX then restarts from BOTTOM. In non-inverting Compare Output mode, the Output Compare (OC2) is cleared on the Compare Match between TCNT2 and OCR2, and set at BOTTOM. In inverting Compare Output mode, the output is set on Compare Match and cleared at BOTTOM. Due to the single-slope operation, the operating frequency of the fast PWM mode can be twice as high as the phase correct PWM mode that uses dual-slope operation. This high frequency makes the fast PWM mode well suited for power regulation, rectification, and DAC applications. High frequency allows physically small sized external components (coils, capacitors), and therefore reduces total system cost.

In fast PWM mode, the counter is incremented until the counter value matches the MAX value. The counter is then cleared at the following timer clock cycle. The timing diagram for the fast PWM mode is shown in the following figure. The TCNT2 value is in the timing diagram shown as a histogram for illustrating the single-slope operation. The diagram includes non-inverted and inverted PWM outputs. The

22.5.2. SPSR – SPI Status Register

When using the I/O specific commands IN and OUT, the I/O addresses 0x00 - 0x3F must be used. When addressing I/O Registers as data space using LD and ST instructions, 0x20 must be added to these offset addresses.

Name: SPSR

Offset: 0x0E

Reset: 0x00

Property: When addressing I/O Registers as data space the offset address is 0x2E

Bit	7	6	5	4	3	2	1	0
	SPIF	WCOL						SPI2X
Access	R	R						R/W
Reset	0	0						0

Bit 7 – SPIF: SPI Interrupt Flag

When a serial transfer is complete, the SPIF Flag is set. An interrupt is generated if SPIE in SPCR is set and global interrupts are enabled. If $\overline{SS}$ is an input and is driven low when the SPI is in Master mode, this will also set the SPIF Flag. SPIF is cleared by hardware when executing the corresponding interrupt handling vector. Alternatively, the SPIF bit is cleared by first reading the SPI Status Register with SPIF set, then accessing the SPI Data Register (SPDR).

Bit 6 – WCOL: Write Collision Flag

The WCOL bit is set if the SPI Data Register (SPDR) is written during a data transfer. The WCOL bit (and the SPIF bit) are cleared by first reading the SPI Status Register with WCOL set, and then accessing the SPI Data Register.

Bit 0 – SPI2X: Double SPI Speed Bit

When this bit is written logic one the SPI speed (SCK Frequency) will be doubled when the SPI is in Master mode (refer to [Table 22-5](#)). This means that the minimum SCK period will be two CPU clock periods. When the SPI is configured as Slave, the SPI is only guaranteed to work at $f_{osc}/4$ or lower.

The SPI interface on the ATmega32A is also used for program memory and EEPROM downloading or uploading. Refer to section [Serial Downloading](#) for serial programming and verification.

23.11. Register Description

Bit 0 – TXB8: Transmit Data Bit 8

TXB8 is the ninth data bit in the character to be transmitted when operating with serial frames with nine data bits. Must be written before writing the low bits to UDR.

Table 24-6. Status Codes for Slave Transmitter Mode

Status Code (TWSR) Prescaler Bits are 0	Status of the 2-wire Serial Bus and 2-wire Serial Interface Hardware	Application Software Response					Next Action Taken by TWI Hardware
		To/from TWDR	To TWCR				
			STA	STO	TWINT	TWEA	
0xA8	Own SLA+R has been received; ACK has been returned	Load data byte or Load data byte	X X	0 0	1 1	0 1	Last data byte will be transmitted and NOT ACK should be received Data byte will be transmitted and ACK should be received
0xB0	Arbitration lost in SLA+R/W as Master; own SLA+R has been received; ACK has been returned	Load data byte or Load data byte	X X	0 0	1 1	0 1	Last data byte will be transmitted and NOT ACK should be received Data byte will be transmitted and ACK should be received
0xB8	Data byte in TWDR has been transmitted; ACK has been received	Load data byte or Load data byte	X X	0 0	1 1	0 1	Last data byte will be transmitted and NOT ACK should be received Data byte will be transmitted and ACK should be received
0xC0	Data byte in TWDR has been transmitted; NOT ACK has been received	No TWDR action or No TWDR action or No TWDR action or No TWDR action	0 0 1 1	0 0 0 0	1 1 1 1	0 1 0 1	Switched to the not addressed Slave mode; no recognition of own SLA or GCA Switched to the not addressed Slave mode; own SLA will be recognized; GCA will be recognized if TWGCE = “1” Switched to the not addressed Slave mode; no recognition of own SLA or GCA; a START condition will be transmitted when the bus becomes free Switched to the not addressed Slave mode; own SLA will be recognized; GCA will be recognized if TWGCE = “1”; a START condition will be transmitted when the bus becomes free
0xC8	Last data byte in TWDR has been transmitted (TWEA = “0”); ACK has been received	No TWDR action or No TWDR action or No TWDR action or No TWDR action	0 0 1 1	0 0 0 0	1 1 1 1	0 1 0 1	Switched to the not addressed Slave mode; no recognition of own SLA or GCA Switched to the not addressed Slave mode; own SLA will be recognized; GCA will be recognized if TWGCE = “1” Switched to the not addressed Slave mode; no recognition of own SLA or GCA; a START condition will be transmitted when the bus becomes free Switched to the not addressed Slave mode; own SLA will be recognized; GCA will be recognized if TWGCE = “1”; a START condition will be transmitted when the bus becomes free

Figure 26-7. ADC Timing Diagram, Free Running Conversion

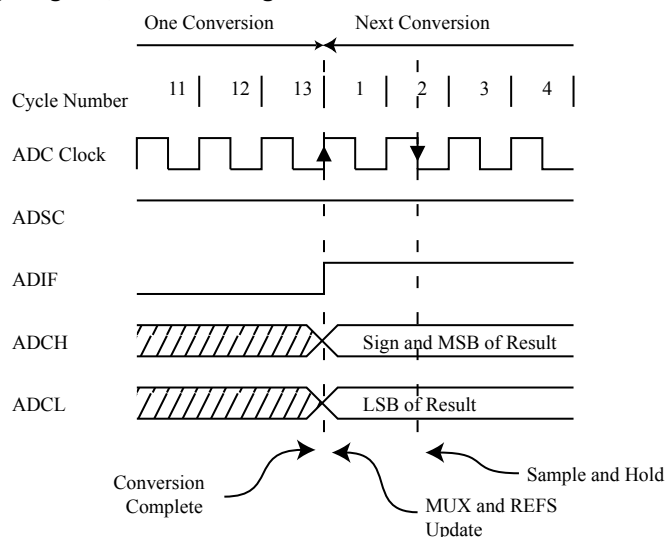


Table 26-1. ADC Conversion Time

Condition	Sample & Hold (Cycles from Start of Conversion)	Conversion Time (Cycles)
First conversion	13.5	25
Normal conversions, single ended	1.5	13
Auto Triggered conversions	2	13.5
Normal conversions, differential	1.5/2.5	13/14

26.4.1. Differential Gain Channels

When using differential gain channels, certain aspects of the conversion need to be taken into consideration.

Differential conversions are synchronized to the internal clock CK_{ADC2} equal to half the ADC clock. This synchronization is done automatically by the ADC interface in such a way that the sample-and-hold occurs at a specific edge of CK_{ADC2} . A conversion initiated by the user (that is, all single conversions, and the first free running conversion) when CK_{ADC2} is low will take the same amount of time as a single ended conversion (13 ADC clock cycles from the next prescaled clock cycle). A conversion initiated by the user when CK_{ADC2} is high will take 14 ADC clock cycles due to the synchronization mechanism. In free running mode, a new conversion is initiated immediately after the previous conversion completes, and since CK_{ADC2} is high at this time, all automatically started (that is, all but the first) free running conversions will take 14 ADC clock cycles.

The gain stage is optimized for a bandwidth of 4kHz at all gain settings. Higher frequencies may be subjected to non-linear amplification. An external low-pass filter should be used if the input signal contains higher frequency components than the gain stage bandwidth. Note that the ADC clock frequency is independent of the gain stage bandwidth limitation. For example the ADC clock period may be 6μs, allowing a channel to be sampled at 12kSPS, regardless of the bandwidth of this channel.

If differential gain channels are used and conversions are started by Auto Triggering, the ADC must be switched off between conversions. When Auto Triggering is used, the ADC prescaler is reset before the conversion is started. Since the gain stage is dependent of a stable ADC clock prior to the conversion, this conversion will not be valid. By disabling and then re-enabling the ADC between each conversion

26.8.1. ADMUX – ADC Multiplexer Selection Register

When using the I/O specific commands IN and OUT, the I/O addresses 0x00 - 0x3F must be used. When addressing I/O Registers as data space using LD and ST instructions, 0x20 must be added to these offset addresses.

Name: ADMUX

Offset: 0x07

Reset: 0x00

Property: When addressing I/O Registers as data space the offset address is 0x27

Bit	7	6	5	4	3	2	1	0
	REFS1	REFS0	ADLAR	MUX4	MUX3	MUX2	MUX1	MUX0
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bits 7:6 – REFSn: Reference Selection [n = 1:0]

These bits select the voltage reference for the ADC. If these bits are changed during a conversion, the change will not go in effect until this conversion is complete (ADIF in ADCSRA is set). The internal voltage reference options may not be used if an external reference voltage is being applied to the AREF pin.

Table 26-3. ADC Voltage Reference Selection

REFS[1:0]	Voltage Reference Selection
00	AREF, Internal V_{ref} turned off
01	AV_{CC} with external capacitor at AREF pin
10	Reserved
11	Internal 2.56V Voltage Reference with external capacitor at AREF pin

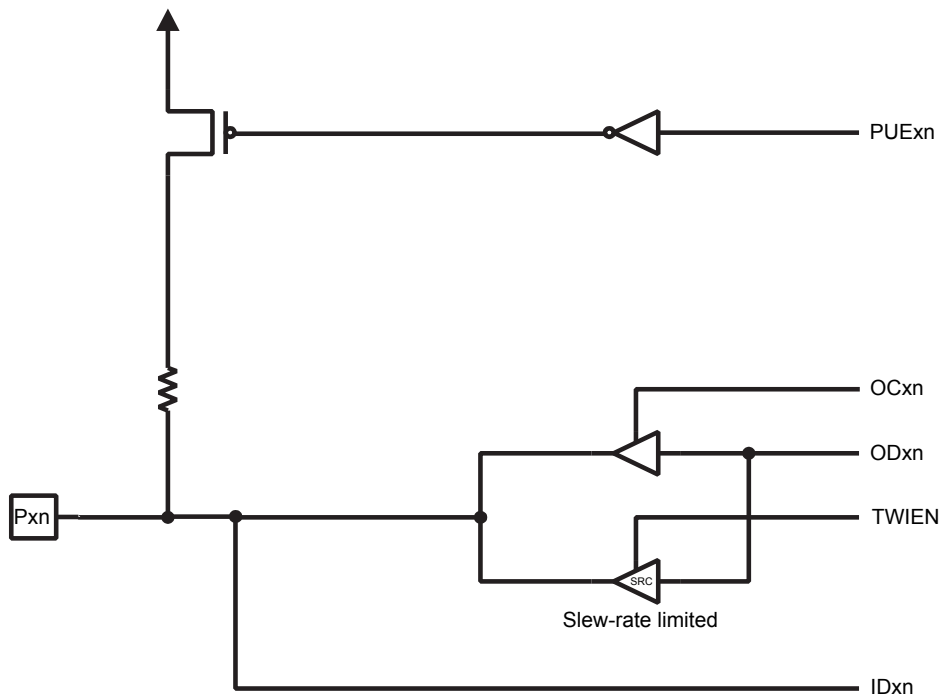
Bit 5 – ADLAR: ADC Left Adjust Result

The ADLAR bit affects the presentation of the ADC conversion result in the ADC Data Register. Write one to ADLAR to left adjust the result. Otherwise, the result is right adjusted. Changing the ADLAR bit will affect the ADC Data Register immediately, regardless of any ongoing conversions. For a complete description of this bit, see [ADCL](#) and [ADCH](#).

Bits 4:0 – MUXn: Analog Channel Selection [n = 4:0]

The value of these bits selects which combination of analog inputs are connected to the ADC. These bits also select the gain for the differential channels. Refer to table below for details. If these bits are changed during a conversion, the change will not go in effect until this conversion is complete (ADIF in [ADCSRA](#) is set).

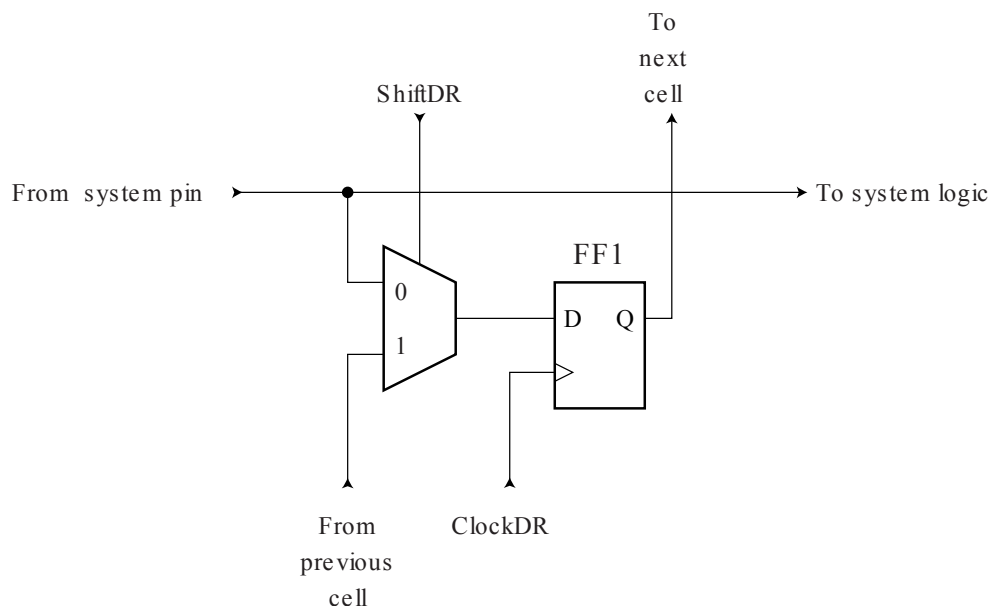
Figure 27-7. Additional Scan Signal for the Two-wire Interface



27.13.3. Scanning the RESET Pin

The RESET pin accepts 5V active low logic for standard Reset operation, and 12V active high logic for High Voltage Parallel programming. An observe-only cell as shown in the figure below is inserted both for the 5V Reset signal; RSTT, and the 12V Reset signal; RSTHV.

Figure 27-8. Observe-only Cell



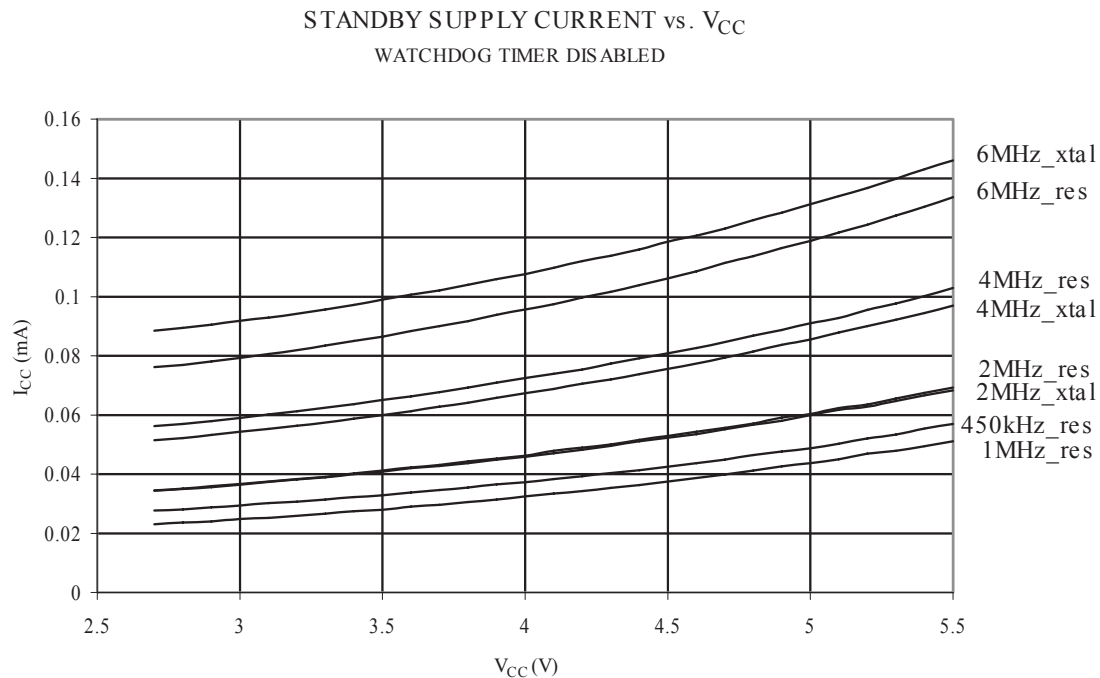
27.13.4. Scanning the Clock Pins

The AVR devices have many clock options selectable by fuses. These are: Internal RC Oscillator, External RC, External Clock, (High Frequency) Crystal Oscillator, Low-frequency Crystal Oscillator, and Ceramic Resonator.

Symbol	Parameter	Condition	Min	Typ	Max	Units
	Integral Non-linearity (INL) (Accuracy after calibration for Offset and Gain Error)	Gain = 1x $V_{REF} = 4V$, $V_{CC} = 5V$ ADC clock = 50 - 200kHz		0.75		LSB
		Gain = 10x $V_{REF} = 4V$, $V_{CC} = 5V$ ADC clock = 50 - 200kHz		0.75		LSB
		Gain = 200x $V_{REF} = 4V$, $V_{CC} = 5V$ ADC clock = 50 - 200kHz		2		LSB
	Gain Error	Gain = 1x		1.6		%
		Gain = 10x		1.5		%
		Gain = 200x		0.2		%
	Offset Error	Gain = 1x $V_{REF} = 4V$, $V_{CC} = 5V$ ADC clock = 50 - 200kHz		1		LSB
		Gain = 10x $V_{REF} = 4V$, $V_{CC} = 5V$ ADC clock = 50 - 200kHz		1.5		LSB
		Gain = 200x $V_{REF} = 4V$, $V_{CC} = 5V$ ADC clock = 50 - 200kHz		4.5		LSB
	Conversion Time		65		260	μs
	Clock Frequency		50		200	kHz
AV_{CC}	Analog Analog Supply Voltage		$V_{CC} - 0.3^{(1)}$		$V_{CC} + 0.3^{(2)}$	V
V_{REF}	Reference Voltage		2.0		$AV_{CC} - 0.5$	V
V_{IN}	Input voltage		GND		AV_{CC}	V
V_{DIFF}	Input differential voltage		$-V_{REF}/Gain$		$V_{REF}/Gain$	V
	ADC conversion output		-511		511	LSB
	Input bandwidth			4		kHz
V_{INT}	Internal Voltage Reference		2.3	2.56	2.7	V

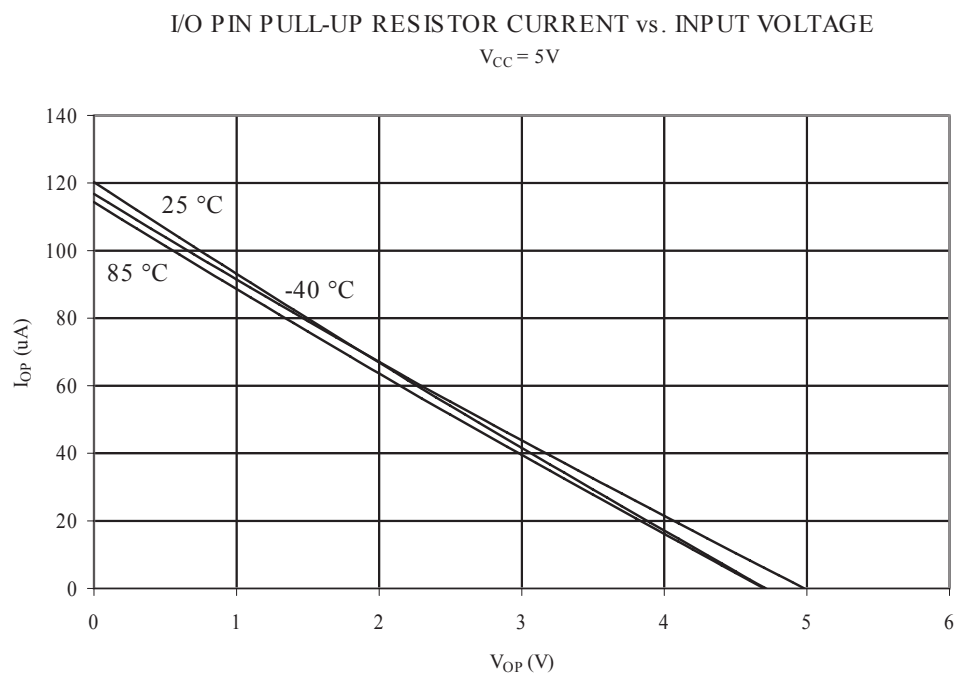
31.5. Standby Supply Current

Figure 31-16. Standby Supply Current vs. V_{CC} (WDT Disabled)



31.6. Pin Pull-up

Figure 31-17. I/O Pin Pull-up Resistor Current vs. Input Voltage (V_{CC} = 5V)



33. Instruction Set Summary

ARITHMETIC AND LOGIC INSTRUCTIONS					
Mnemonics	Operands	Description	Operation	Flags	#Clocks
ADD	Rd, Rr	Add two Registers	$Rd \leftarrow Rd + Rr$	Z,C,N,V,H	1
ADC	Rd, Rr	Add with Carry two Registers	$Rd \leftarrow Rd + Rr + C$	Z,C,N,V,H	1
ADIW	Rdl,K	Add Immediate to Word	$Rdh:Rdl \leftarrow Rdh:Rdl + K$	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract two Registers	$Rd \leftarrow Rd - Rr$	Z,C,N,V,H	1
SUBI	Rd, K	Subtract Constant from Register	$Rd \leftarrow Rd - K$	Z,C,N,V,H	1
SBC	Rd, Rr	Subtract with Carry two Registers	$Rd \leftarrow Rd - Rr - C$	Z,C,N,V,H	1
SBCI	Rd, K	Subtract with Carry Constant from Reg.	$Rd \leftarrow Rd - K - C$	Z,C,N,V,H	1
SBIW	Rdl,K	Subtract Immediate from Word	$Rdh:Rdl \leftarrow Rdh:Rdl - K$	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND Registers	$Rd \leftarrow Rd \cdot Rr$	Z,N,V	1
ANDI	Rd, K	Logical AND Register and Constant	$Rd \leftarrow Rd \cdot K$	Z,N,V	1
OR	Rd, Rr	Logical OR Registers	$Rd \leftarrow Rd \vee Rr$	Z,N,V	1
ORI	Rd, K	Logical OR Register and Constant	$Rd \leftarrow Rd \vee K$	Z,N,V	1
EOR	Rd, Rr	Exclusive OR Registers	$Rd \leftarrow Rd \oplus Rr$	Z,N,V	1
COM	Rd	One's Complement	$Rd \leftarrow 0xFF - Rd$	Z,C,N,V	1
NEG	Rd	Two's Complement	$Rd \leftarrow 0x00 - Rd$	Z,C,N,V,H	1
SBR	Rd,K	Set Bit(s) in Register	$Rd \leftarrow Rd \vee K$	Z,N,V	1
CBR	Rd,K	Clear Bit(s) in Register	$Rd \leftarrow Rd \cdot (0xFF - K)$	Z,N,V	1
INC	Rd	Increment	$Rd \leftarrow Rd + 1$	Z,N,V	1
DEC	Rd	Decrement	$Rd \leftarrow Rd - 1$	Z,N,V	1
TST	Rd	Test for Zero or Minus	$Rd \leftarrow Rd \cdot Rd$	Z,N,V	1
CLR	Rd	Clear Register	$Rd \leftarrow Rd \oplus Rd$	Z,N,V	1
SER	Rd	Set Register	$Rd \leftarrow 0xFF$	None	1
MUL	Rd, Rr	Multiply Unsigned	$R1:R0 \leftarrow Rd \times Rr$	Z,C	2
MULS	Rd, Rr	Multiply Signed	$R1:R0 \leftarrow Rd \times Rr$	Z,C	2
MULSU	Rd, Rr	Multiply Signed with Unsigned	$R1:R0 \leftarrow Rd \times Rr$	Z,C	2
FMUL	Rd, Rr	Fractional Multiply Unsigned	$R1:R0 \leftarrow (Rd \times Rr) \ll 1$	Z,C	2
FMULS	Rd, Rr	Fractional Multiply Signed	$R1:R0 \leftarrow (Rd \times Rr) \ll 1$	Z,C	2
FMULSU	Rd, Rr	Fractional Multiply Signed with Unsigned	$R1:R0 \leftarrow (Rd \times Rr) \ll 1$	Z,C	2

BRANCH INSTRUCTIONS					
Mnemonics	Operands	Description	Operation	Flags	#Clocks
RJMP	k	Relative Jump	$PC \leftarrow PC + k + 1$	None	2
IJMP		Indirect Jump to (Z)	$PC \leftarrow Z$	None	2
JMP ⁽¹⁾	k	Direct Jump	$PC \leftarrow k$	None	3
RCALL	k	Relative Subroutine Call	$PC \leftarrow PC + k + 1$	None	3